



Data sheet acquired from Harris Semiconductor  
SCHS015

## CMOS NOR Gates

### High-Voltage Types (20-Volt Rating)

Quad 2 Input – CD4001B

Dual 4 Input – CD4002B

Triple 3 Input – CD4025B

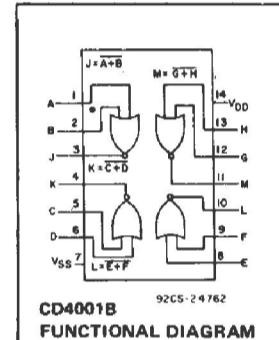
**CD4001B, CD4002B, and CD4025B**  
NOR gates provide the system designer with direct implementation of the NOR function and supplement the existing family of CMOS gates. All inputs and outputs are buffered.

The CD4001B, CD4002B, and CD4025B types are supplied in 14-lead hermetic dual-in-line ceramic packages (D and F suffixes), 14-lead dual-in-line plastic packages (E suffix), and in chip form (H suffix).

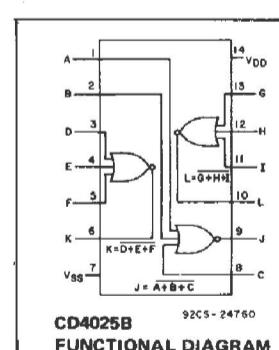
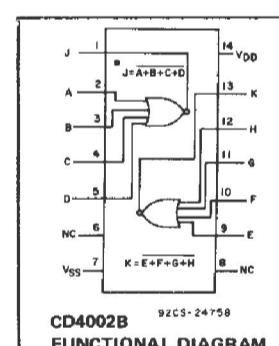
## CD4001B, CD4002B, CD4025B Types

### Features:

- Propagation delay time = 60 ns (typ.) at  $C_L = 50 \text{ pF}$ ,  $V_{DD} = 10 \text{ V}$
- Buffered inputs and outputs
- Standardized symmetrical output characteristics
- 100% tested for maximum quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of  $1 \mu\text{A}$  at 18 V over full package-temperature range;  $100 \text{ nA}$  at 18 V and  $25^\circ\text{C}$
- Noise margin (over full package temperature range):
  - 1 V at  $V_{DD} = 5 \text{ V}$
  - 2 V at  $V_{DD} = 10 \text{ V}$
  - 2.5 V at  $V_{DD} = 15 \text{ V}$
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of "B" Series CMOS Devices"



3  
COMMERCIAL CMOS  
HIGH VOLTAGE ICs



### STATIC ELECTRICAL CHARACTERISTICS

| CHARACTERISTIC                              | CONDITIONS   |                 |                 | LIMITS AT INDICATED TEMPERATURES ( $^\circ\text{C}$ ) |           |         |         |       |               | UNITS      |               |
|---|--------------|-----------------|-----------------|---|-----------|---------|---------|-------|---------------|------------|---------------|
|   | $V_O$<br>(V) | $V_{IN}$<br>(V) | $V_{DD}$<br>(V) | -55   | -40       | +85     | +125    | Min.  | Typ.          | Max.       |               |
| Quiescent Device Current, $I_{DD}$ Max.     | –            | 0,5             | 5               | 0,25  | 0,25      | 7,5     | 7,5     | –     | 0,01          | 0,25       | $\mu\text{A}$ |
|   | –            | 0,10            | 10              | 0,5   | 0,5       | 15      | 15      | –     | 0,01          | 0,5        |               |
|   | –            | 0,15            | 15              | 1   | 1         | 30      | 30      | –     | 0,01          | 1          |               |
|   | –            | 0,20            | 20              | 5   | 5         | 150     | 150     | –     | 0,02          | 5          |               |
| Output Low (Sink) Current, $I_{OL}$ Min.    | 0,4          | 0,5             | 5               | 0,64  | 0,61      | 0,42    | 0,36    | 0,51  | 1             | –          | $\text{mA}$   |
|   | 0,5          | 0,10            | 10              | 1,6   | 1,5       | 1,1     | 0,9     | 1,3   | 2,6           | –          |               |
|   | 1,5          | 0,15            | 15              | 4,2   | 4         | 2,8     | 2,4     | 3,4   | 6,8           | –          |               |
| Output High (Source) Current, $I_{OH}$ Min. | 4,6          | 0,5             | 5               | -0,64   | -0,61     | -0,42   | -0,36   | -0,51 | -1            | –          | $\text{mA}$   |
|   | 2,5          | 0,5             | 5               | -2  | -1,8      | -1,3    | -1,15   | -1,6  | -3,2          | –          |               |
|   | 9,5          | 0,10            | 10              | -1,6  | -1,5      | -1,1    | -0,9    | -1,3  | -2,6          | –          |               |
|   | 13,5         | 0,15            | 15              | -4,2  | -4        | -2,8    | -2,4    | -3,4  | -6,8          | –          |               |
| Output Voltage: Low-Level, $V_{OL}$ Max.    | –            | 0,5             | 5               | 0,05  |           |         | –       | 0     | 0,05          | $\text{V}$ |               |
|   | –            | 0,10            | 10              | 0,05  |           |         | –       | 0     | 0,05          |            |               |
|   | –            | 0,15            | 15              | 0,05  |           |         | –       | 0     | 0,05          |            |               |
| Output Voltage: High-Level, $V_{OH}$ Min.   | –            | 0,5             | 5               | 4,95  |           |         | 4,95    | 5     | –             | $\text{V}$ |               |
|   | –            | 0,10            | 10              | 9,95  |           |         | 9,95    | 10    | –             |            |               |
|   | –            | 0,15            | 15              | 14,95   |           |         | 14,95   | 15    | –             |            |               |
| Input Low Voltage, $V_{IL}$ Max.            | 0,5,4,5      | –               | 5               | 1,5   |           |         | –       | –     | 1,5           | $\text{V}$ |               |
|   | 1,9          | –               | 10              | 3   |           |         | –       | –     | 3             |            |               |
|   | 1,5,13,5     | –               | 15              | 4   |           |         | –       | –     | 4             |            |               |
| Input High Voltage, $V_{IH}$ Min.           | 0,5          | –               | 5               | 3,5   |           |         | 3,5     | –     | –             | $\text{V}$ |               |
|   | 1            | –               | 10              | 7   |           |         | 7       | –     | –             |            |               |
|   | 1,5          | –               | 15              | 11  |           |         | 11      | –     | –             |            |               |
| Input Current $I_{IN}$ Max.                 |              | 0,18            | 18              | $\pm 0,1$   | $\pm 0,1$ | $\pm 1$ | $\pm 1$ | –     | $\pm 10^{-5}$ | $\pm 0,1$  | $\mu\text{A}$ |

## CD4001B, CD4002B, CD4025B Types

### RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC  | LIMITS |      | UNITS |
|---|--------|------|-------|
|   | MIN.   | MAX. |       |
| Supply-Voltage Range (For $T_A$ = Full Package Temperature Range) | 3      | 18   | V     |

### MAXIMUM RATINGS, Absolute-Maximum Values:

#### DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ )

Voltages referenced to  $V_{SS}$  Terminal) ..... -0.5V to +20V  
INPUT VOLTAGE RANGE, ALL INPUTS ..... -0.5V to  $V_{DD}$  +0.5V

DC INPUT CURRENT, ANY ONE INPUT .....  $\pm 10\text{mA}$

POWER DISSIPATION PER PACKAGE ( $P_D$ ):

For  $T_A = -55^\circ\text{C}$  to  $+100^\circ\text{C}$  ..... 500mW

For  $T_A = +100^\circ\text{C}$  to  $+125^\circ\text{C}$ , Derate Linearity at  $12\text{mW}/^\circ\text{C}$  to 200mW

### DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR  $T_A$  = FULL PACKAGE-TEMPERATURE RANGE (All Package Types) ..... 100mW

OPERATING-TEMPERATURE RANGE ( $T_A$ ) ..... -55°C to +125°C

STORAGE TEMPERATURE RANGE ( $T_{STG}$ ) ..... -65°C to +150°C

LEAD TEMPERATURE (DURING SOLDERING):

At distance  $1/16 \pm 1/32$  inch (1.59 ± 0.79mm) from case for 10s max .....  $+265^\circ\text{C}$

### DYNAMIC ELECTRICAL CHARACTERISTICS

At  $T_A = 25^\circ\text{C}$ ; Input  $t_f$ ,  $t_r$  = 20 ns,  $C_L = 50\text{ pF}$ ,  $R_L = 200\text{k}\Omega$

| CHARACTERISTIC                                | TEST CONDITIONS | ALL TYPES LIMITS |      | UNITS |    |
|---|-----------------|------------------|------|-------|----|
|   |                 | $V_{DD}$ VOLTS   | TYP. | MAX.  |    |
| Propagation Delay Time,<br>$t_{PHL}, t_{PLH}$ |                 | 5                | 125  | 250   | ns |
|   |                 | 10               | 60   | 120   |    |
|   |                 | 15               | 45   | 90    |    |
| Transition Time,<br>$t_{THL}, t_{TLH}$        |                 | 5                | 100  | 200   | ns |
|   |                 | 10               | 50   | 100   |    |
|   |                 | 15               | 40   | 80    |    |
| Input Capacitance, $C_{IN}$                   | Any Input       |                  | 5    | 7.5   | pF |

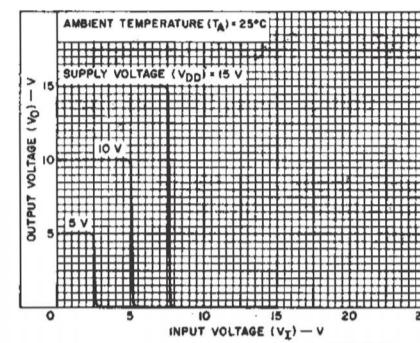


Fig. 1 – Typical voltage transfer characteristics.

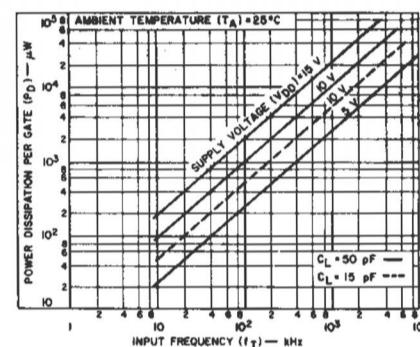


Fig. 2 – Typical power dissipation vs. frequency.

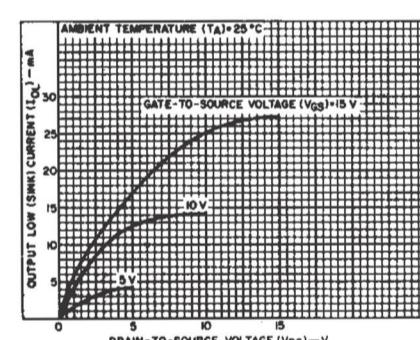


Fig. 3 – Typical output low (sink) current characteristics.

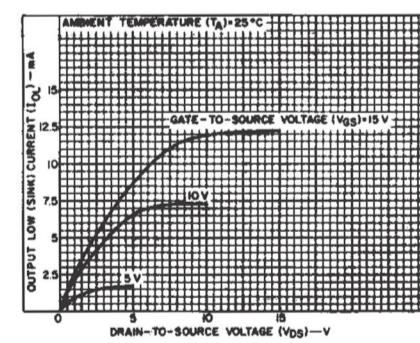


Fig. 4 – Minimum output low (sink) current characteristics.

### CD4001B, CD4002B, CD4025B Types

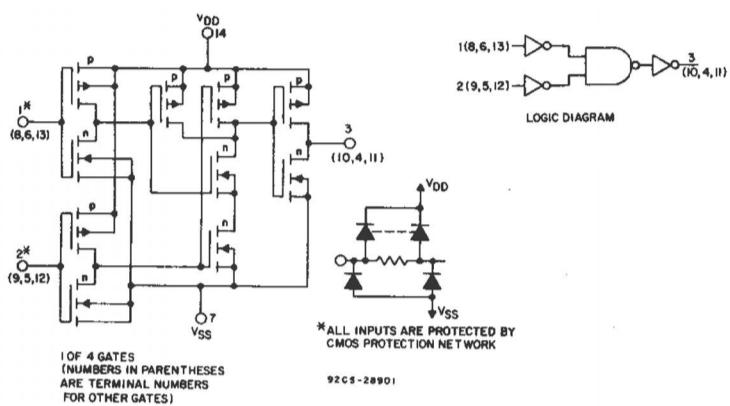


Fig. 5 – Schematic and logic diagrams for CD4001B.

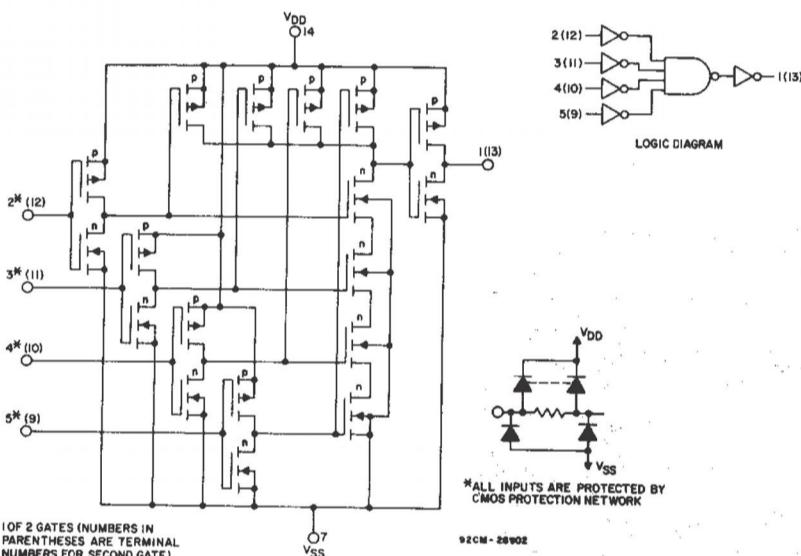


Fig. 6 – Schematic and logic diagrams for CD4002B.

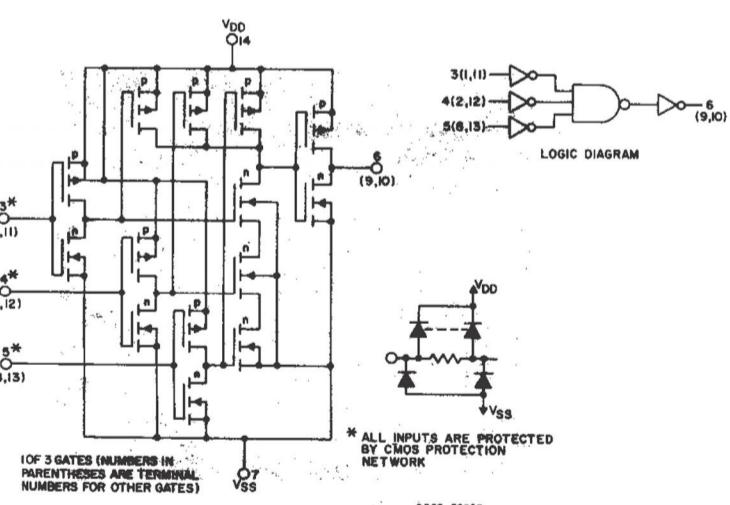


Fig. 7 – Schematic and logic diagrams for CD4025B.

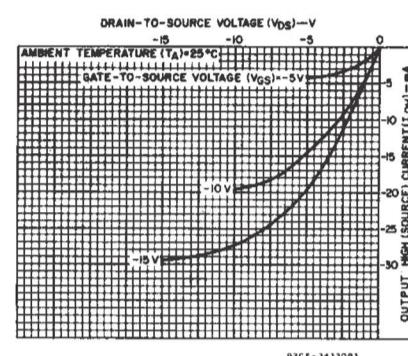


Fig. 8 – Typical output high (source) current characteristics.

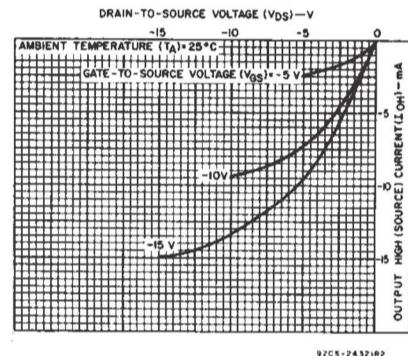


Fig. 9 – Minimum output high (source) current characteristics.

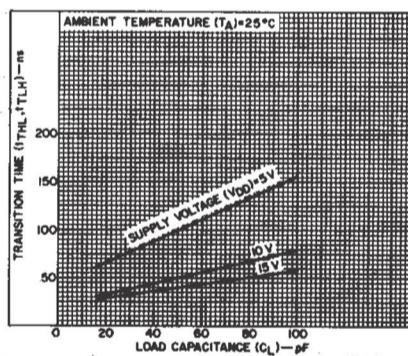


Fig. 10 – Typical transition time vs. load capacitance.

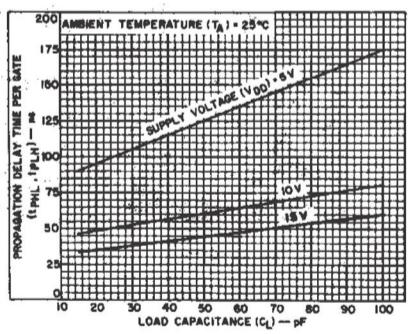


Fig. 11 – Typical propagation delay time vs. load capacitance.

### CD4001B, CD4002B, CD4025B Types

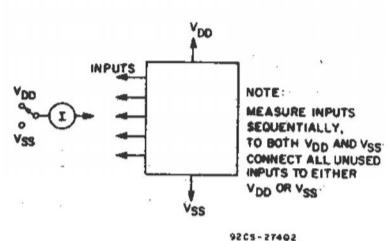


Fig. 13 — Input leakage current test circuit.

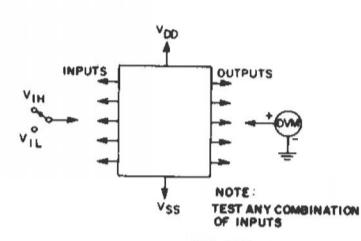


Fig. 14 — Input-voltage test circuit.

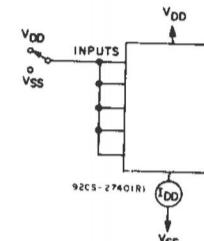
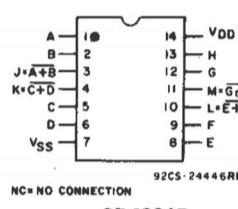
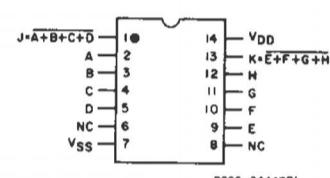


Fig. 15 — Quiescent-device current test circuit.

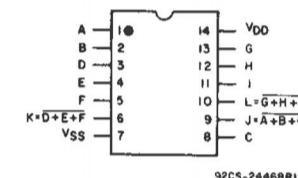
#### TERMINAL ASSIGNMENTS (TOP VIEW)



CD4001B

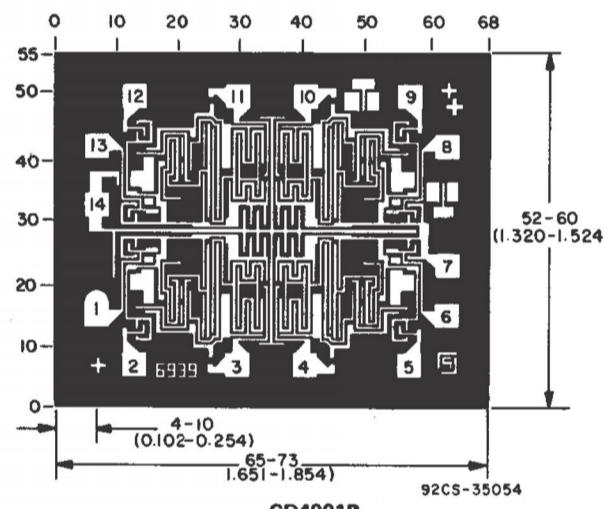


CD4002B

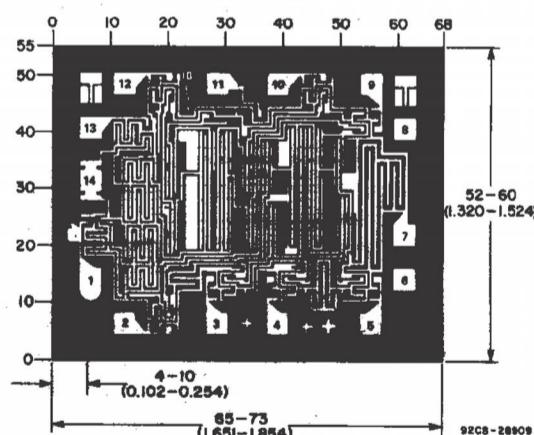


CD4025B

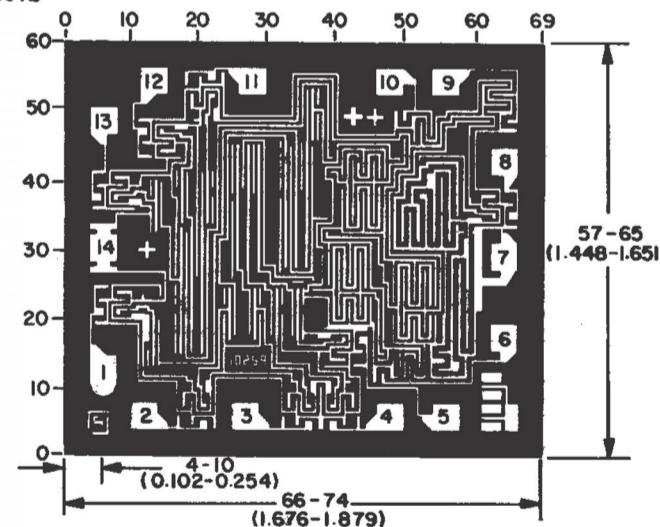
#### Chip Dimensions and Pad Layouts



CD4001B



CD4002B



CD4025B

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